



Customer Information Notification

202307006I : LPC804M101JHI33 Marking Format Update To Add Assembly Site Code

Note: This notice is NXP Company Proprietary.

Issue Date: Aug 09, 2023 **Effective date:** Aug 10, 2023

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Management summary

The LPC804M101JHI33 marking format will be updated to add an assembly site code.

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage
<input type="checkbox"/> Firmware <input type="checkbox"/> Other				

PCN Overview

Description

The LPC804M101JHI33 marking format will be updated to add an assembly site code. The effective date code will be 2334.

An assembly site code character is added to the last line of the top side marking in place of the first character of the date code.

A new datasheet has been issued with updated marking information.

https://www.nxp.com/docs/en/nxp/data-sheets/LPC804_DS.pdf.

Reason

To provide traceability for multiple assembly site sourcing.

Identification of Affected Products

Top Side Marking

An assembly site code character is added in place of the first character of the date code in the last line of the top side marking. See marking description in the product datasheet.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

Data Sheet Revision

A new datasheet will be issued

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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